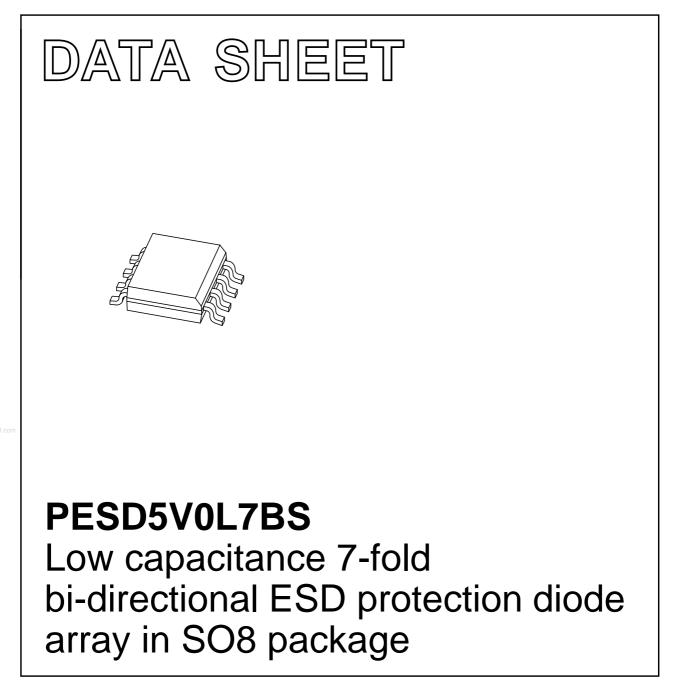
DISCRETE SEMICONDUCTORS



Product specification

2004 Mar 15



PESD5V0L7BS

FEATURES

- Bi-directional ESD protection of up to 7 lines
- Low diode capacitance
- Max. peak pulse power: $P_{pp} = 35$ W at $t_p = 8/20 \ \mu s$
- Low clamping voltage: V_{(CL)R} = 17 V at I_{pp} = 2.5 A
- Ultra low leakage current: $I_{RM} = 3 \text{ nA}$ at $V_{RWM} = 5 \text{ V}$
- ESD protection: >10 kV
- IEC 61000-4-2; level 4 (ESD)
- IEC 61000-4-5; (surge): $I_{pp} = 2.5 \text{ A at } t_p = 8/20 \text{ } \mu\text{s}.$

APPLICATIONS

- Computers and peripherals
- Communication systems
- Audio and video equipment
- High speed data lines
- Parallel ports.

DESCRIPTION

Low capacitance 7-fold bi-directional ESD protection diode array in a small SO8 plastic package, designed to protect up to seven transmission or data lines from ElectroStatic Discharge (ESD) damage.

MARKING

TYPE NUMBER	MARKING CODE		
PESD5V0L7BS	5V0L7BS		

ORDERING INFORMATION

TYPE NUMBER	PACKAGE				
	NAME	NAME DESCRIPTION VERSION			
PESD5V0L7BS	SO8	plastic small outline package; 8 leads; body width 3.9 mm SOT9			

QUICK REFERENCE DATA

SYMBOL	PARAMETER	VALUE	UNIT	
V _{RWM}	reverse stand-off voltage	5	V	
C _d	diode capacitance; V _R = 0 V; f = 1 MHz	8	pF	
	number of protected lines	7		

PINNING

PIN	DESCRIPTION
1, 2, 3, 4, 5, 6, 7, 8	cathodes

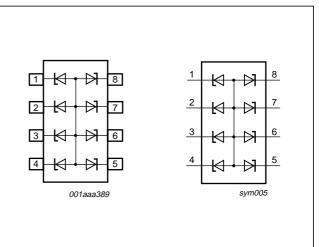


Fig.1 Simplified outline (SO8) and symbol.

PESD5V0L7BS

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
P _{pp}	peak pulse power	8/20 μs pulse; note 1	-	35	W
I _{pp}	peak pulse current	8/20 μs pulse; note 1	-	2.5	А
T _{amb}	operating ambient temperature		-65	+150	°C
Tj	junction temperature –		-	150	°C
T _{stg}	storage temperature –65 +			+150	°C

Notes

1. Non-repetitive current pulse 8/20 µs exponential decay waveform; see Fig.2.

ESD maximum ratings

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
ESD	electrostatic discharge	IEC 61000-4-2 (contact discharge); note 1	10	kV
	capability	HBM MIL-Std 883	10	kV

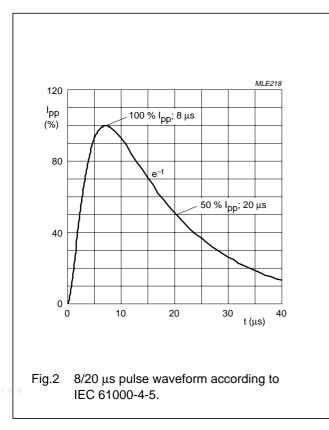
Notes

1. Device stressed with ten non-repetitive ESD pulses; see Fig.3.

ESD standards compliance

IEC 61000-4-2, level 4 (ESD); see Fig.3	> 8 kV (contact)		
HBM MIL-Std 883, class 3	> 4 kV		

Low capacitance 7-fold bi-directional ESD protection diode array in SO8 package



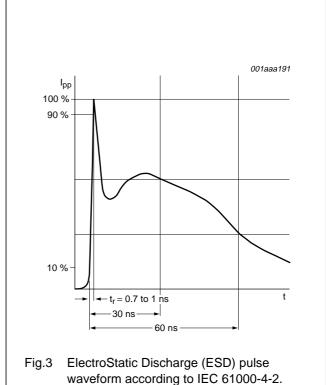
ELECTRICAL CHARACTERISTICS

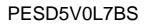
 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

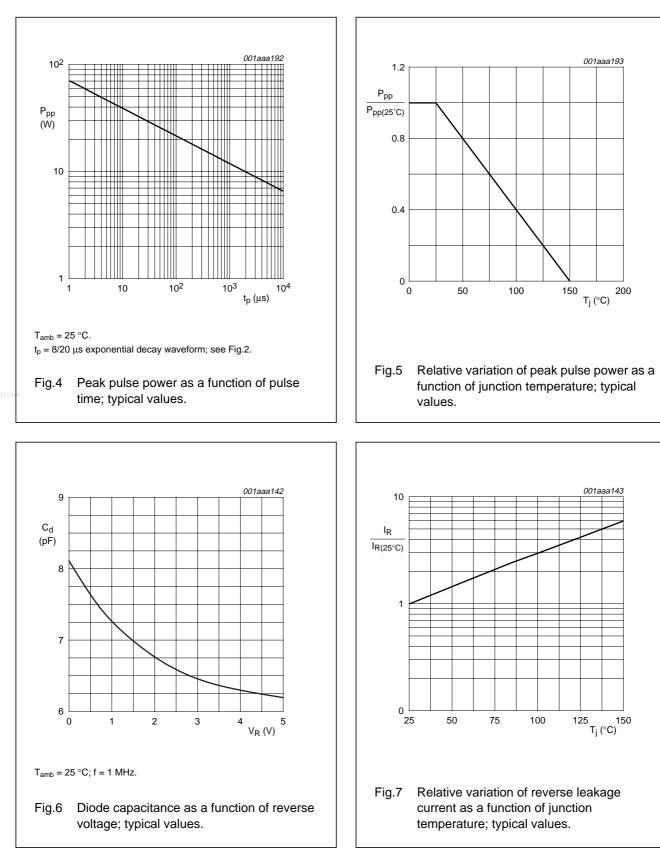
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per diode						
V _{RWM}	reverse stand-off voltage		-	-	5	V
I _{RM}	reverse leakage current	V _{RWM} = 5 V	_	3	25	nA
V _{(CL)R}	clamping voltage	note 1				
		$I_{pp} = 1 A$	-	-	11	V
		$I_{pp} = 1 A$ $I_{pp} = 2.5 A$	-	_	17	V
V _{BR}	breakdown voltage	$I_R = 1 \text{ mA}$	7.2	7.6	7.9	V
R _{diff}	differential resistance	I _R = 1 mA	-	-	100	Ω
C _d	diode capacitance	V _R = 0 V; f = 1 MHz	_	8	10	pF

Note

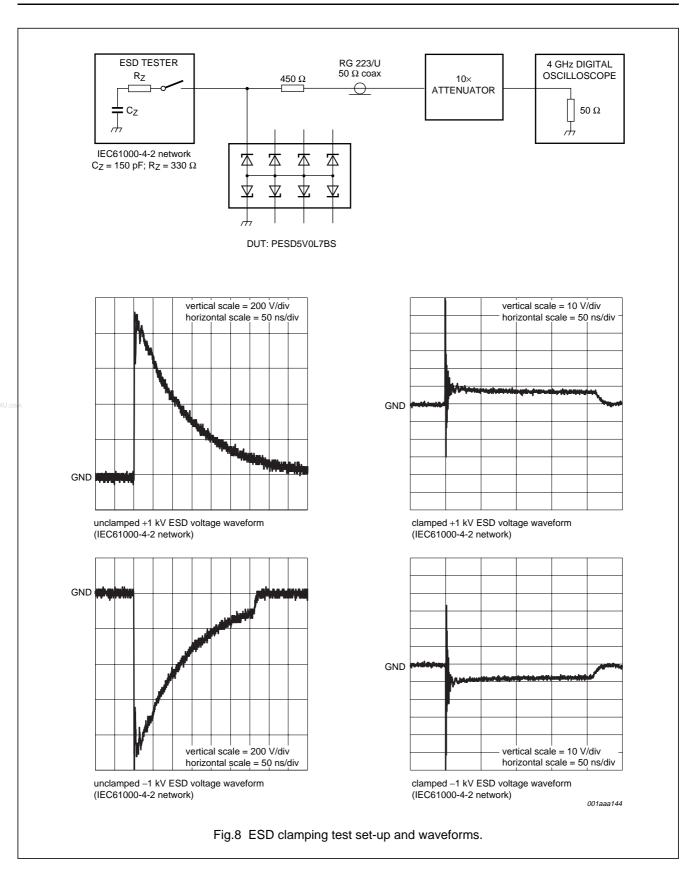
1. Non-repetitive current pulse 8/20 µs exponentially decaying waveform; see Fig.2.







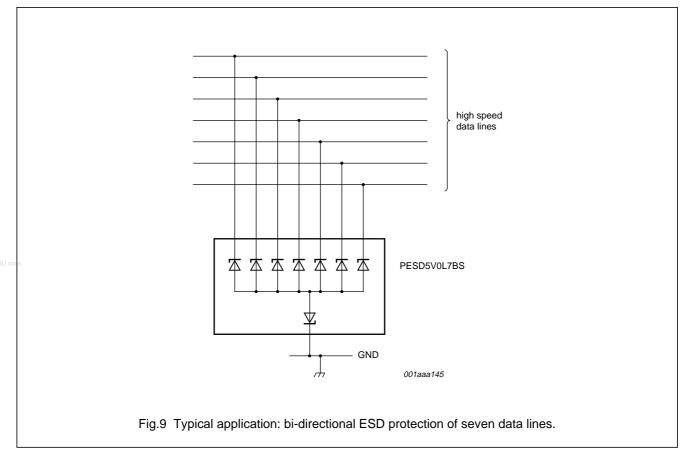
Low capacitance 7-fold bi-directional ESD protection diode array in SO8 package



APPLICATION INFORMATION

The PESD5V0L7BS can protect up to seven lines against damage caused by bi-directional ElectroStatic Discharge (ESD) and surge pulses whose polarities. The PESD5V0L7BS can be used to protect lines whose signal polarities are above and below ground. The PESD5V0L7BS provides a surge capability of 35 W (P_{pp}) per line for a 8/20 μ s waveform.

Typical application



Circuit board layout and protection device placement

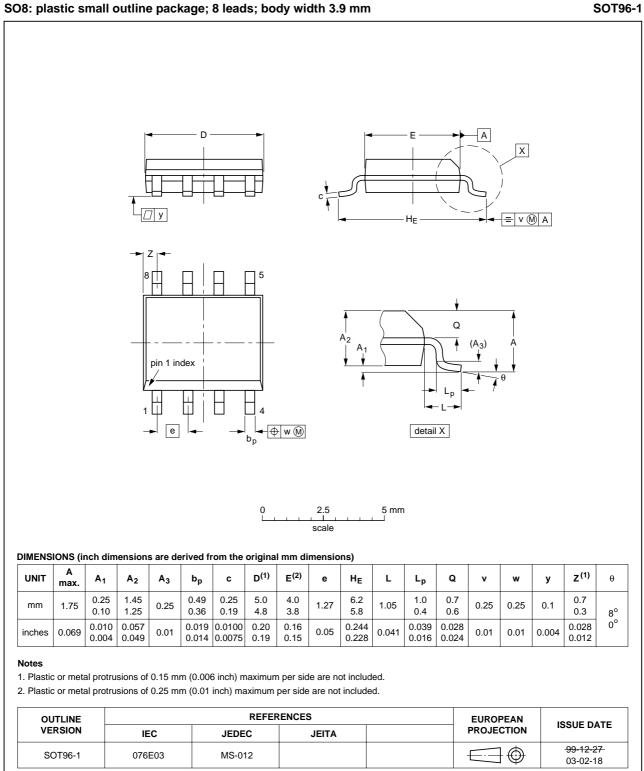
Circuit board layout is critical for the suppression of ESD, EFT and surge transients. The following guidelines are recommended:

- Place the PESD5V0L7BS as close as possible to the input terminal or connector
- Minimize the path length between the PESD5V0L7BS and the protected line
- Keep parallel signal paths to a minimum
- · Avoid running protected conductors in parallel with unprotected conductors
- · Minimize all printed-circuit board conductive loops including power and group loops
- Minimize the length of transient return paths to ground
- · Avoid using shared return paths to a common ground point
- Ground planes should be used whenever possible.
- Use vias for multi-layer printed-circuit boards.

PESD5V0L7BS

Low capacitance 7-fold bi-directional ESD protection diode array in SO8 package

PACKAGE OUTLINE



Low capacitance 7-fold bi-directional ESD protection diode array in SO8 package

9

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

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- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

R76/01/pp10

Date of release: 2004 Mar 15

Document order number: 9397 750 12249

SCA76

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